

## Description

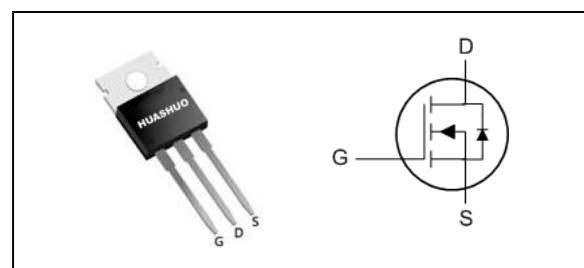
The HSP6024A is the high cell density trenched N-ch MOSFETs, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications. The HSP6024A meet the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.

- Super Low Gate Charge
- 100% EAS Guaranteed
- Green Device Available
- Excellent CdV/dt effect decline
- Advanced high cell density Trench technology

## Product Summary

V <sub>DS</sub>	60	V
R <sub>DS(ON),max</sub>	4.8	mΩ
I <sub>D</sub>	200	A

## TO220 Pin Configuration



## Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V <sub>DS</sub>	Drain-Source Voltage	60	V
V <sub>GS</sub>	Gate-Source Voltage	±20	V
I <sub>D</sub> @T <sub>C</sub> =25°C	Continuous Drain Current <sup>1</sup>	200	A
I <sub>D</sub> @T <sub>C</sub> =25°C	Continuous Drain Current <sup>6</sup>	120	A
I <sub>D</sub> @T <sub>C</sub> =100°C	Continuous Drain Current <sup>1,6</sup>	140	A
I <sub>DM</sub>	Pulsed Drain Current <sup>2</sup>	340	A
EAS	Single Pulse Avalanche Energy <sup>3</sup>	245	mJ
I <sub>AS</sub>	Avalanche Current	70	A
P <sub>D</sub> @T <sub>C</sub> =25°C	Total Power Dissipation <sup>4</sup>	260	W
P <sub>D</sub> @T <sub>A</sub> =25°C	Total Power Dissipation <sup>4</sup>	2.02	W
T <sub>STG</sub>	Storage Temperature Range	-55 to 150	°C
T <sub>J</sub>	Operating Junction Temperature Range	-55 to 150	°C

## Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
R <sub>θJA</sub>	Thermal Resistance Junction-Ambient <sup>1</sup>	---	62	°C/W
R <sub>θJC</sub>	Thermal Resistance Junction-Case <sup>1</sup>	---	0.45	°C/W

**Electrical Characteristics ( $T_J=25^\circ\text{C}$ , unless otherwise noted)**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$\text{V}_{\text{GS}}=0\text{V}$ , $\text{I}_D=250\mu\text{A}$	60	---	---	V
$\text{R}_{\text{DS}(\text{ON})}$	Static Drain-Source On-Resistance <sup>2</sup>	$\text{V}_{\text{GS}}=10\text{V}$ , $\text{I}_D=30\text{A}$	---	3.8	4.8	$\text{m}\Omega$
$\text{V}_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$\text{V}_{\text{GS}}=\text{V}_{\text{DS}}$ , $\text{I}_D=250\mu\text{A}$	2.5	---	4.5	V
$\text{I}_{\text{DSS}}$	Drain-Source Leakage Current	$\text{V}_{\text{DS}}=48\text{V}$ , $\text{V}_{\text{GS}}=0\text{V}$ , $T_J=25^\circ\text{C}$	---	---	1	uA
		$\text{V}_{\text{DS}}=48\text{V}$ , $\text{V}_{\text{GS}}=0\text{V}$ , $T_J=55^\circ\text{C}$	---	---	5	
$\text{I}_{\text{GSS}}$	Gate-Source Leakage Current	$\text{V}_{\text{GS}}=\pm 20\text{V}$ , $\text{V}_{\text{DS}}=0\text{V}$	---	---	$\pm 100$	nA
$\text{g}_{\text{fs}}$	Forward Transconductance	$\text{V}_{\text{DS}}=5\text{V}$ , $\text{I}_D=30\text{A}$	---	50	---	S
$\text{R}_{\text{g}}$	Gate Resistance	$\text{V}_{\text{DS}}=0\text{V}$ , $\text{V}_{\text{GS}}=0\text{V}$ , $f=1\text{MHz}$	---	1.4	---	$\Omega$
$\text{Q}_{\text{g}}$	Total Gate Charge (10V)	$\text{V}_{\text{DS}}=48\text{V}$ , $\text{V}_{\text{GS}}=10\text{V}$ , $\text{I}_D=15\text{A}$	---	83.7	---	nC
$\text{Q}_{\text{gs}}$	Gate-Source Charge		---	28.6	---	
$\text{Q}_{\text{gd}}$	Gate-Drain Charge		---	29.3	---	
$\text{T}_{\text{d}(\text{on})}$	Turn-On Delay Time	$\text{V}_{\text{DD}}=30\text{V}$ , $\text{V}_{\text{GS}}=10\text{V}$ , $\text{R}_{\text{g}}=3.3\Omega$ , $\text{I}_D=48\text{A}$	---	38.1	---	ns
$\text{T}_{\text{r}}$	Rise Time		---	73.3	---	
$\text{T}_{\text{d}(\text{off})}$	Turn-Off Delay Time		---	51.6	---	
$\text{T}_{\text{f}}$	Fall Time		---	26.1	---	
$\text{C}_{\text{iss}}$	Input Capacitance	$\text{V}_{\text{DS}}=15\text{V}$ , $\text{V}_{\text{GS}}=0\text{V}$ , $f=1\text{MHz}$	---	5580	---	pF
$\text{C}_{\text{oss}}$	Output Capacitance		---	571	---	
$\text{C}_{\text{rss}}$	Reverse Transfer Capacitance		---	278	---	

**Diode Characteristics**

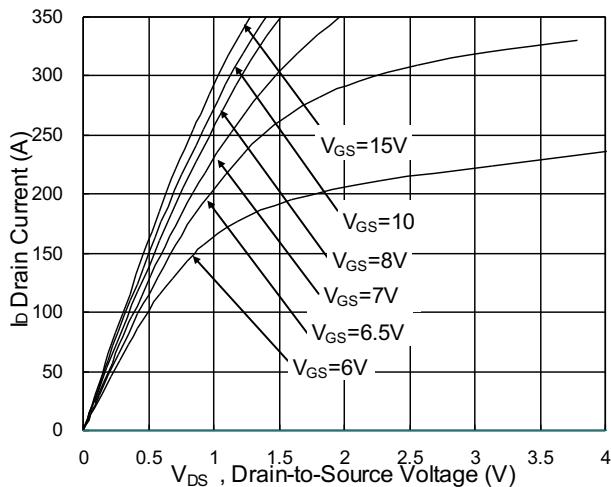
Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$\text{I}_{\text{s}}$	Continuous Source Current <sup>1,5</sup>	$\text{V}_{\text{G}}=\text{V}_{\text{D}}=0\text{V}$ , Force Current	---	---	80	A
$\text{V}_{\text{SD}}$	Diode Forward Voltage <sup>2</sup>	$\text{V}_{\text{GS}}=0\text{V}$ , $\text{I}_{\text{s}}=1\text{A}$ , $T_J=25^\circ\text{C}$	---	---	1.2	V
$\text{t}_{\text{rr}}$	Reverse Recovery Time	$\text{I}_{\text{F}}=30\text{A}$ , $\text{di}/\text{dt}=100\text{A}/\mu\text{s}$ , $T_J=25^\circ\text{C}$	---	30	---	nS
$\text{Q}_{\text{rr}}$	Reverse Recovery Charge		---	55	---	nC

Note :

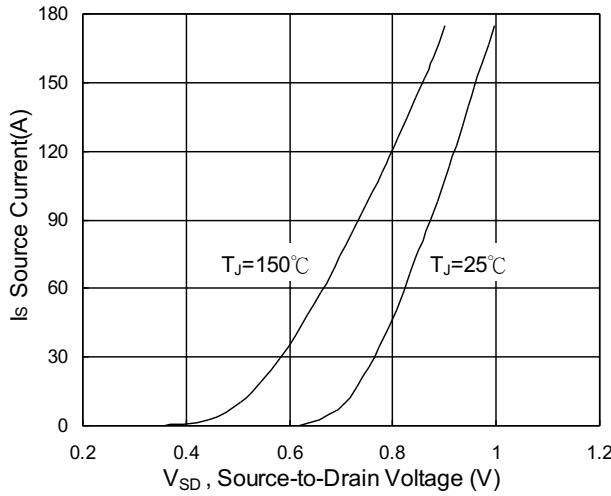
- 1.The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width  $\leq 300\mu\text{s}$  , duty cycle  $\leq 2\%$
- 3.The EAS data shows Max. rating . The test condition is  $\text{V}_{\text{DD}}=50\text{V}$ , $\text{V}_{\text{GS}}=10\text{V}$ , $\text{L}=0.1\text{mH}$ , $\text{I}_{\text{AS}}=70\text{A}$
- 4.The power dissipation is limited by  $150^\circ\text{C}$  junction temperature
- 5.The data is theoretically the same as  $\text{I}_{\text{D}}$  and  $\text{I}_{\text{DM}}$  , in real applications , should be limited by total power dissipation.
- 6.Calculated continuous current based on maximum allowable junction temperature. Package limitation current is 120A.



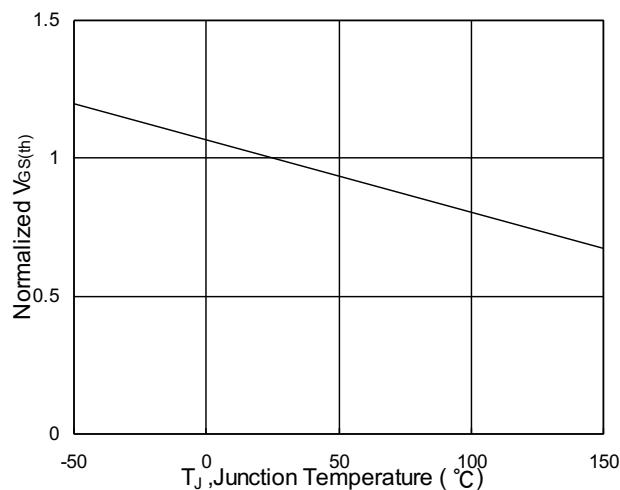
### Typical Characteristics



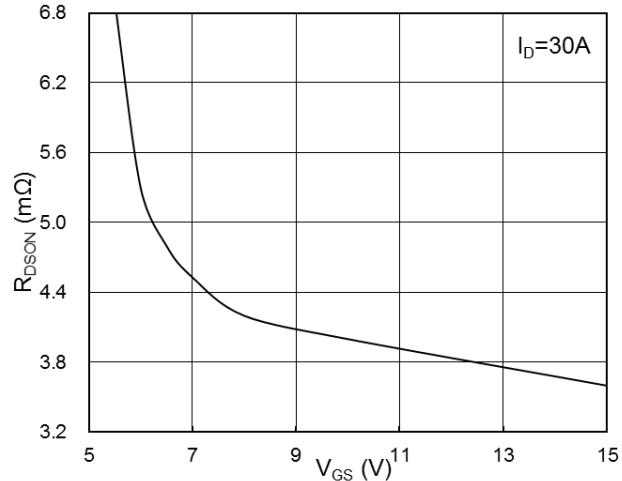
**Fig.1 Typical Output Characteristics**



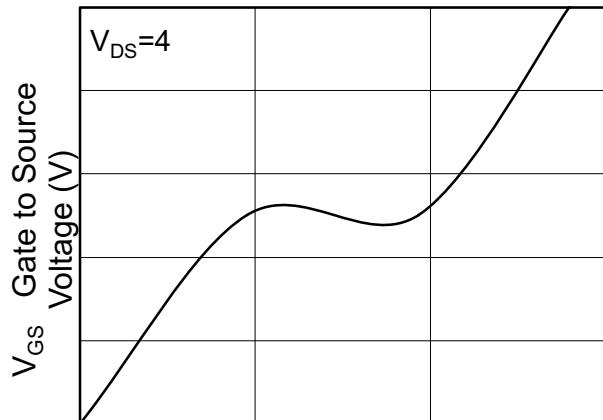
**Fig.3 Source Drain Forward Characteristics**



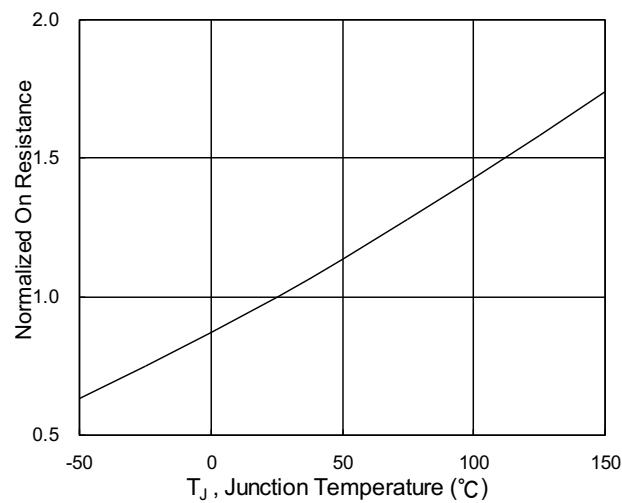
**Fig.5 Normalized  $V_{GS(th)}$  vs.  $T_J$**



**Fig.2 On-Resistance vs. G-S Voltage**



**Fig.4 Gate-Charge Characteristics**



**Fig.6 Normalized  $R_{DS(on)}$  vs.  $T_J$**



HUASHUO  
SEMICONDUCTOR

HSP6024A

N-Ch 60V Fast Switching MOSFETs

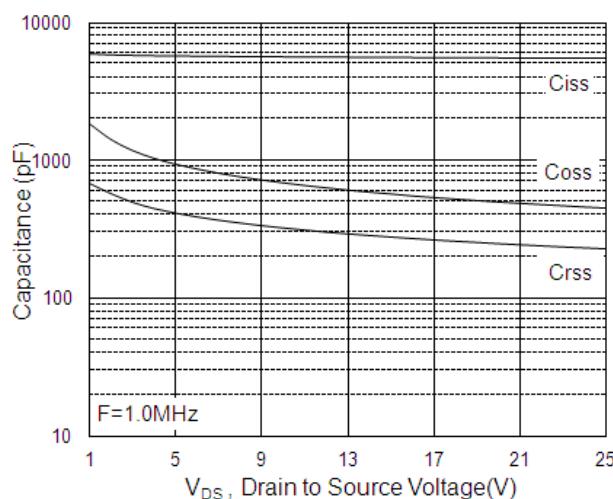


Fig.7 Capacitance

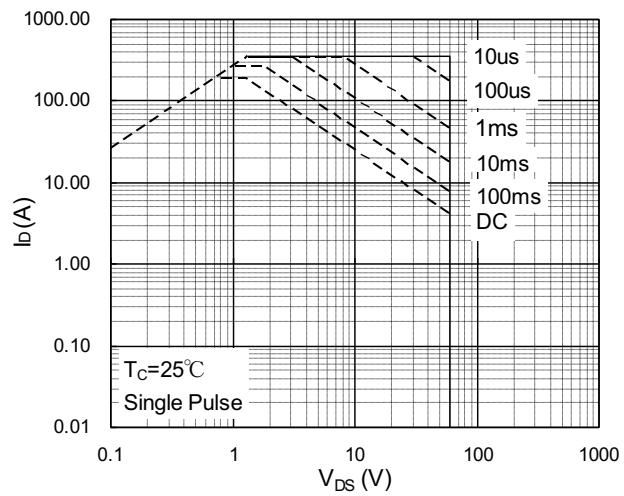


Fig.8 Safe Operating Area

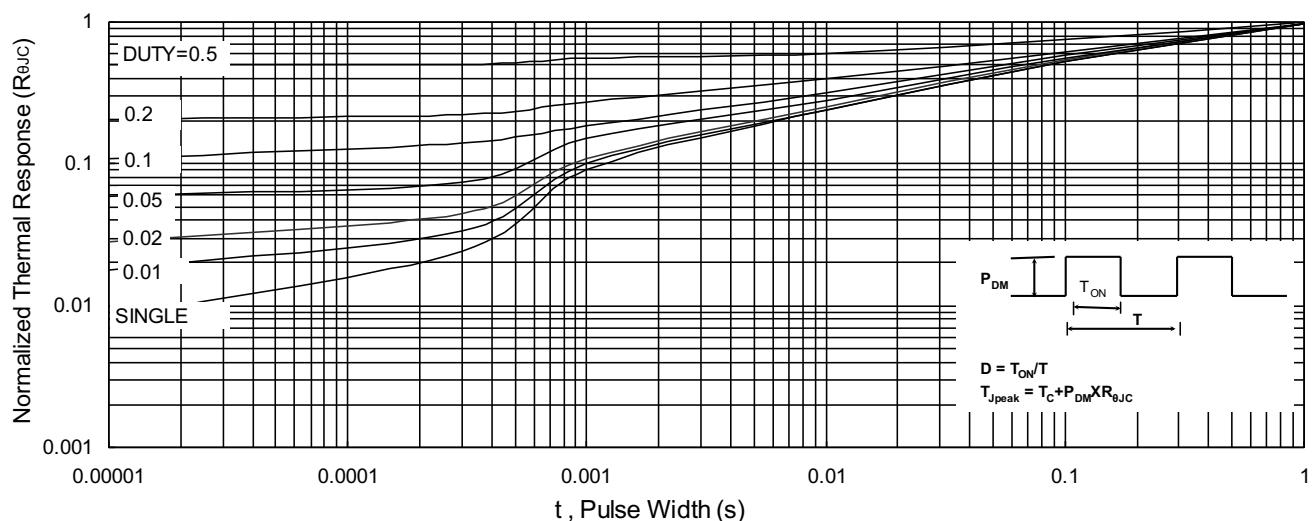


Fig.9 Normalized Maximum Transient Thermal Impedance

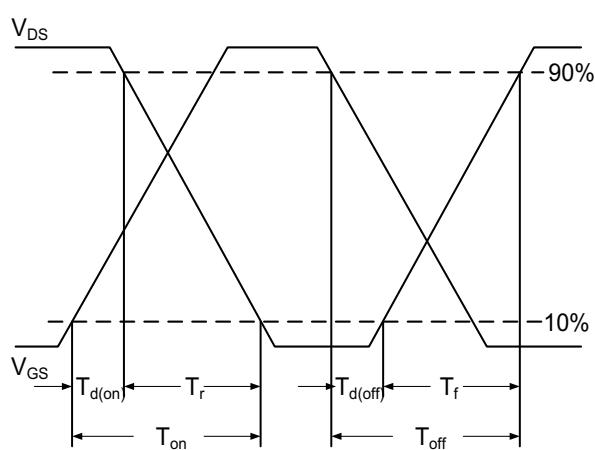


Fig.10 Switching Time Waveform

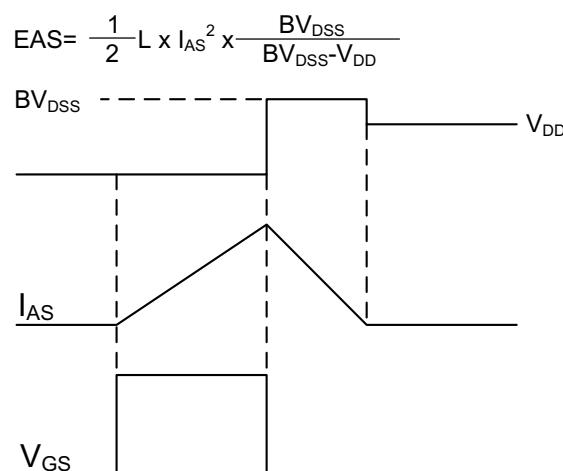


Fig.11 Unclamped Inductive Switching

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